



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 45 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : PBT+30%G.F UL94V-0.
2. INSETER MATERIAL : PBT+30%G.F UL94V-0.
3. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
4. PLATING : GOLD PLATING OVER NICKEL.
5. OPERATING LIFE : 750 CYCLES MIN.
6. PCB RETENTION PRE-SOLDER : 1 LB MIN.
7. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 2. OPERATION: 0°C TO 70°C.
 3. WAVE SOLDER TEMPERATURE: 230°C TO 250°C 5~10 SECONDS.
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191
ROHS PART NUMBER: E5688-XSC08X-L

- 1- 3U" 2- 6U"
 - 3- 15U" 4- 30U"
 - 5- 50U"
- SHIELD
2 w/o logo TIN
3 w/o logo NICKEL

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD

DETACHED LISTS	MM (INCH)	DFTO ANKUE	DATE 11/25/05	FULL RISE ELECTRONIC CO., LTD		
	TOLERANCES EXCEPT AS NOTED	CHKDASHELLY	DATE 2005/11/25			
	MM	MFO	DATE	TITLE 11.5 SIDE ENTRY PCB JACK 8P (W/TABS)		
	.0 ±0.20	APPVLLUSHENG	DATE 2005/11/25			
.00 ±0.15	MATERIAL :	QT'Y :	DRAWING NO. GE563135-LC		SIZE	REV
.000 ±0.075	ANGLES ±	FINISH :	/PART NO. SEE NOTE		A3	0
THIRD ANGLE PROJECTION	SCALE :	DO NOT SCALE DRAWING	SHEET X		OF Y	